

RoHS

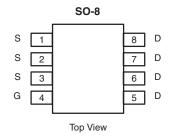
COMPLIANT

HALOGEN FREE Available

Vishay Siliconix

## N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
30	0.0032 at V <sub>GS</sub> = 10 V	36	25.5 nC			
	0.0042 at $V_{GS}$ = 4.5 V	29	23.5110			

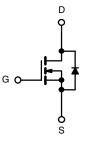


#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Available
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested

#### **APPLICATIONS**

- Synchronous Buck-Low Side
  - Notebook
  - Server
  - Workstation
- Synchronous Rectifier-POL



N-Channel MOSFET

Ordering Information: Si4324DY-T1-E3 (Lead (Pb)-free) Si4324DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		36		
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C		29		
Continuous Drain Current $(1) = 150^{\circ}$ C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	24 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		19 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	70	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	la la	7.0		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	اا	3.0 <sup>b, c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	40		
Avalanche Energy		E <sub>AS</sub>	80	mJ	
	T <sub>C</sub> = 25 °C		7.8		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	P <sub>D</sub>	5.0	w	
	T <sub>A</sub> = 25 °C		3.5 <sup>b, c</sup>	vv	
	T <sub>A</sub> = 70 °C	1	2.2 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	29	35	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	13	16		

Notes:

a. Based on  $T_C = 25 \ ^{\circ}C$ .

d. Maximum under Steady State conditions is 80 °C/W.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

## Si4324DY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•	<u> </u>		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		34		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 6.4			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.4		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	— μΑ	
		$V_{DS}$ = 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			Α	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0025	0.0032	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 15 A		0.0034	0.0042		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		80		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			3510		pF	
Output Capacitance	C <sub>OSS</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		795			
Reverse Transfer Capacitance	C <sub>rss</sub>			265			
	Q <sub>g</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		55.5	85	nC	
Total Gate Charge				25.5	40		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		11.6			
Gate-Drain Charge	Q <sub>gd</sub>			6.6			
Gate Resistance	Rg	f = 1 MHz	0.6	1.25	1.9	Ω	
Turn-on Delay Time	t <sub>d(on)</sub>			30	45	ns	
Rise Time	t <sub>r</sub>			185	280		
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$ $I_D \cong$ 10 A, $V_{GEN}$ = 4.5 V, $R_q$ = 1 $\Omega$		30	45		
Fall Time	t <sub>f</sub>	$D = 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.0 \text{ V}, \text{ Hg} = 1.22$		13	20		
Turn-on Delay Time	t <sub>d(on)</sub>			17	26		
Rise Time	t <sub>r</sub>			90	140		
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$ $I_D \cong$ 10 A, $V_{GEN}$ = 10 V, $R_a$ = 1 $\Omega$		37	56		
Fall Time	t <sub>f</sub>	$D = 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ H}_{\text{g}} = 1.22$		10	16		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	ا <sub>S</sub>	$T_{C} = 25 \ ^{\circ}C$			7	۸	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				70	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 3 A		0.72	1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			40	60	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			40	60	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 13 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		21		1	
Reverse Recovery Rise Time	t <sub>b</sub>	-		19		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing.

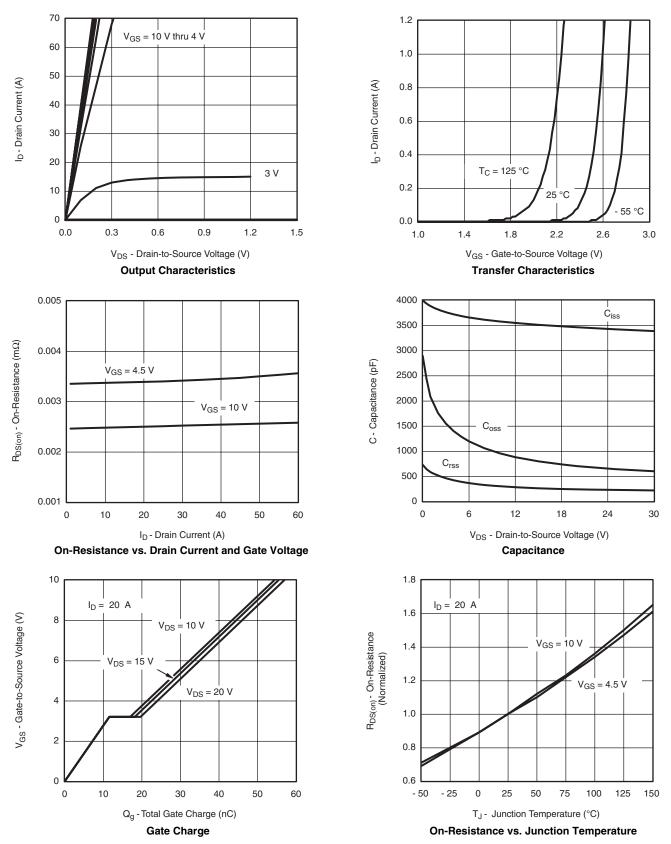
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



# Si4324DY

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

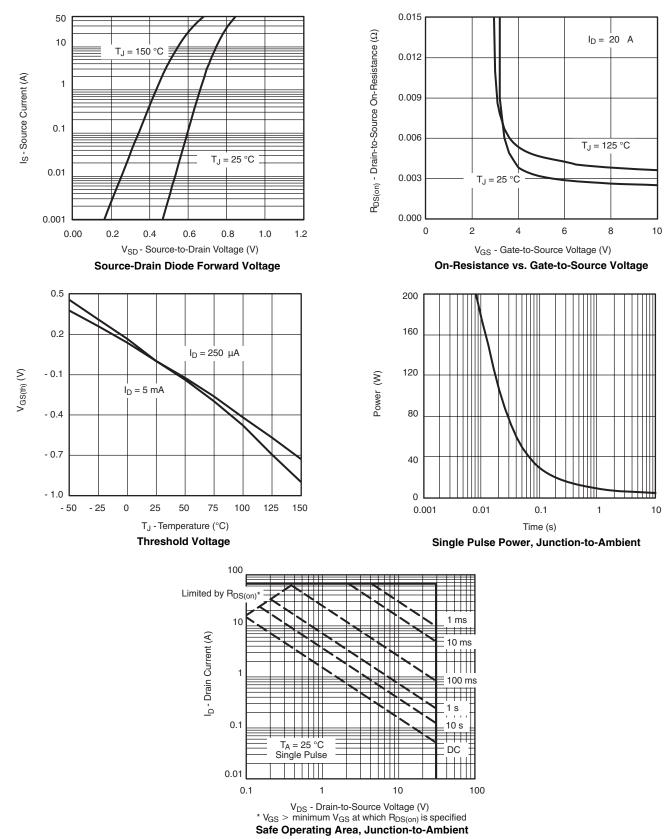


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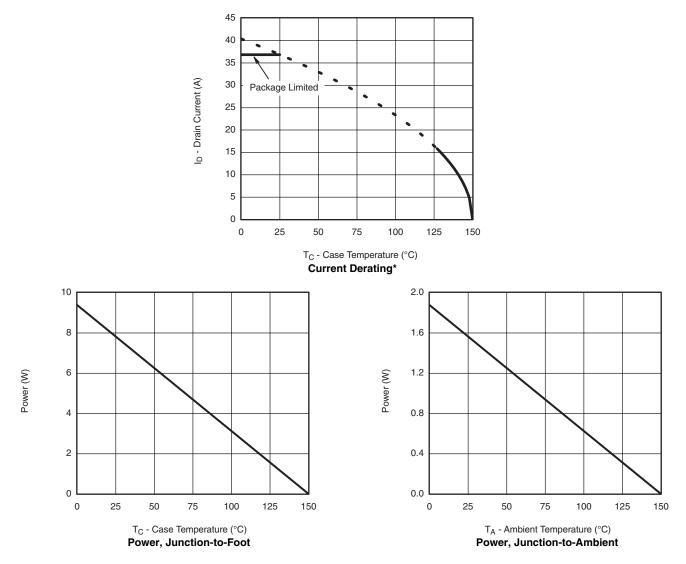
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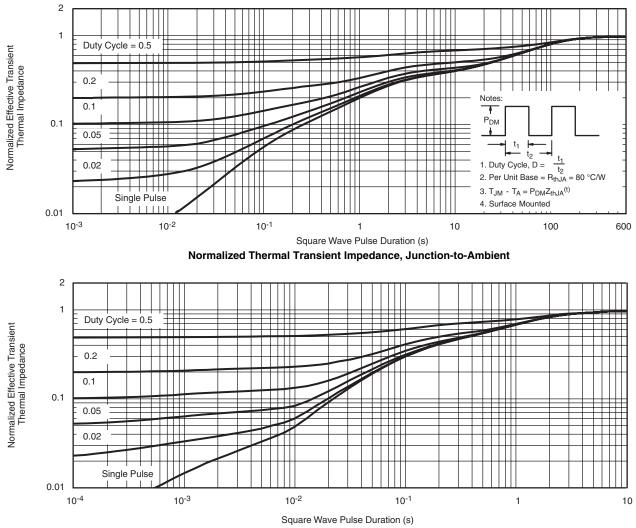


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?73340</u>.



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